

Actual Size = 5 x 7mm



Product Features

- Less than 1.5 ps RMS jitter with fundamental or overtone design
- 2.5V CMOS compatible logic levels
- Pin-compatible with standard 5x7mm packages
- Designed for standard reflow and washing techniques
- Low power standby mode
- Pb-free and RoHS/Green compliant

Product Description

The S1614 Series is a 2.5V crystal clock oscillator that achieves superb jitter and stability over a broad range of operating conditions and frequencies. The output clock signal, generated internally with a non-PLL oscillator design, is compatible with LVCMOS logic levels. The device, available on tape and reel, is contained in a 5x7mm surface-mount ceramic package.

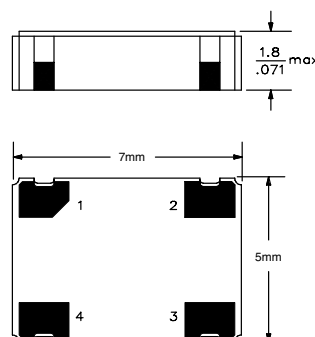
Applications

The S1614 Series is an ideal reference clock for applications requiring low jitter or tight stability, including:

- Ethernet
- FibreChannel
- Serial Attached SCSI (SAS)
- Server & Storage platforms
- SONET/SDH linecards
- T1/E1, T3/E3 linecards
- DSLAM
- 802.11a/b/g WiFi



Packaging Outline



Pin Functions

Pin	Function
1	OE Function
2	Ground
3	Clock Output
4	V _{DD}

Common Frequencies

Contact SaRonix for additional frequencies

1.5440 Mhz	22.0000 MHz	44.7360 MHz
2.0480 MHz	24.5760 MHz	48.0000 MHz
3.6864 MHz	25.0000 MHz	50.0000 MHz
8.0000 MHz	32.0000 MHz	60.0000 MHz
10.0000 MHz	32.7680 MHz	66.0000 MHz
14.3181 MHz	33.0000 MHz	66.6667 MHz
16.0000 MHz	34.3680 MHz	74.2500 MHz
16.3840 MHz	35.3280 MHz	75.0000 MHz
18.4320 MHz	38.8800 MHz	77.7600 MHz
19.4400 MHz	40.0000 MHz	80.0000 MHz
20.0000 MHz	44.0000 MHz	90.0000 MHz

Ordering Information

SaRonix	S	1614	B	- 75.0000	(T)	Packaging
Product Series						(T) = Tape & Reel full reel increments Blank = Bulk packaged
Frequency Stability						Output Frequency (MHz) Note: Recommend S1614XP Series for applications 100 MHz and higher
*AA = ±20 ppM (-10 to +70 °C) *A = ±25 ppM (-10 to +70 °C) B = ±50 ppM (-10 to +70 °C) E = ±50 ppM (-40 to +85°C)						

* Availability varies by frequency.

Electrical Performance

Parameter		Min.	Typ.	Max.	Units	Notes
Output frequency		1.544		125	MHz	As specified
Supply voltage		+2.375	+2.5	+2.625	V	
Supply current, output enabled				15	mA	1.544 to 32 MHz
				25		>32 to 50 MHz
				35		>50 to 125 MHz
Supply current, standby mode				10	μA	Output Hi-Z
Frequency stability				±20 to ±50	ppM	See Note 1 below
Operating temperature		-40		+85	°C	As specified
Output logic 0, VOL				10% V _{DD}	V	
Output logic 1, VOH		90% V _{DD}			V	
Output load		15 pF (max)				
Duty cycle		45		55	%	-40 to +85°C measured 50%VDD
Rise and fall time	up to 32 MHz			10	ns	measured 20/80% of waveform
	>32 to 70 MHz			7		
	>70 to 125 MHz			3		
Jitter, Phase	up to 80 MHz			1.5	ps RMS (1-σ)	10kHz to 20 MHz frequency band
	>80 to 125 MHz			1		
Jitter, Accumulated	up to 80 MHz			5	ps RMS (1-σ)	20.000 adjacent periods
	>80 to 125 MHz			3		
Jitter, Total	up to 80 MHz			50	ps pk-pk	100.000 random periods
	>80 to 125 MHz			30		

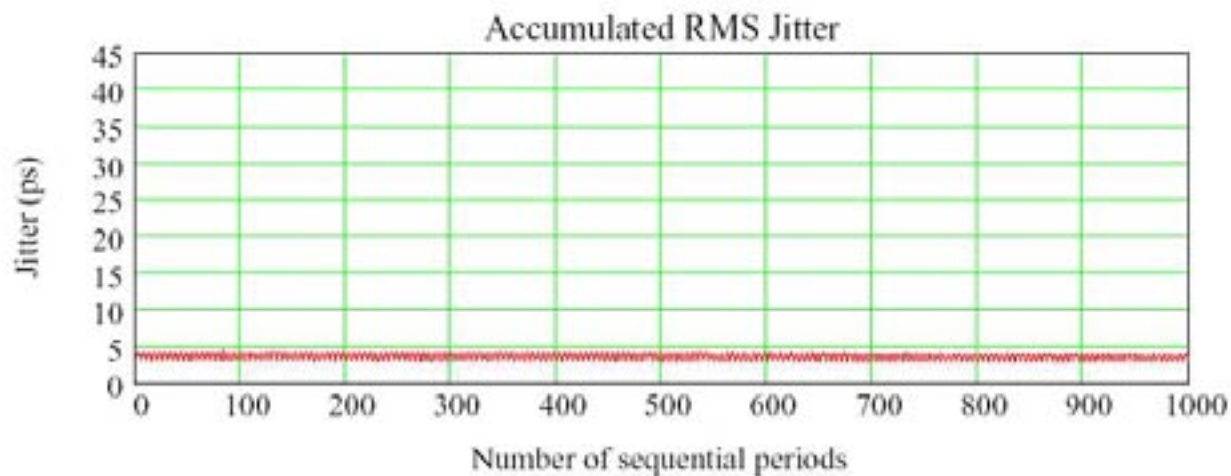
Notes:

- As specified. Stability includes all combinations of operating temperature, load changes, rated input (supply) voltage changes, initial calibration tolerance (25°C), aging (1 year at 25°C average effective ambient temperature), shock and vibration.

Output Enable / Disable Function

Parameter	Min.	Typ.	Max.	Units	Notes
Input Voltage (pin 1), Output Enable	0.7 V _{DD}			V	or open
Input voltage (pin 1), Output Disable (low power standby)			0.3 V _{DD}	V	Output is Hi-Z
Internal pullup resistance	50			kΩ	
Output disable delay			100	ns	
Output enable delay			10	ms	

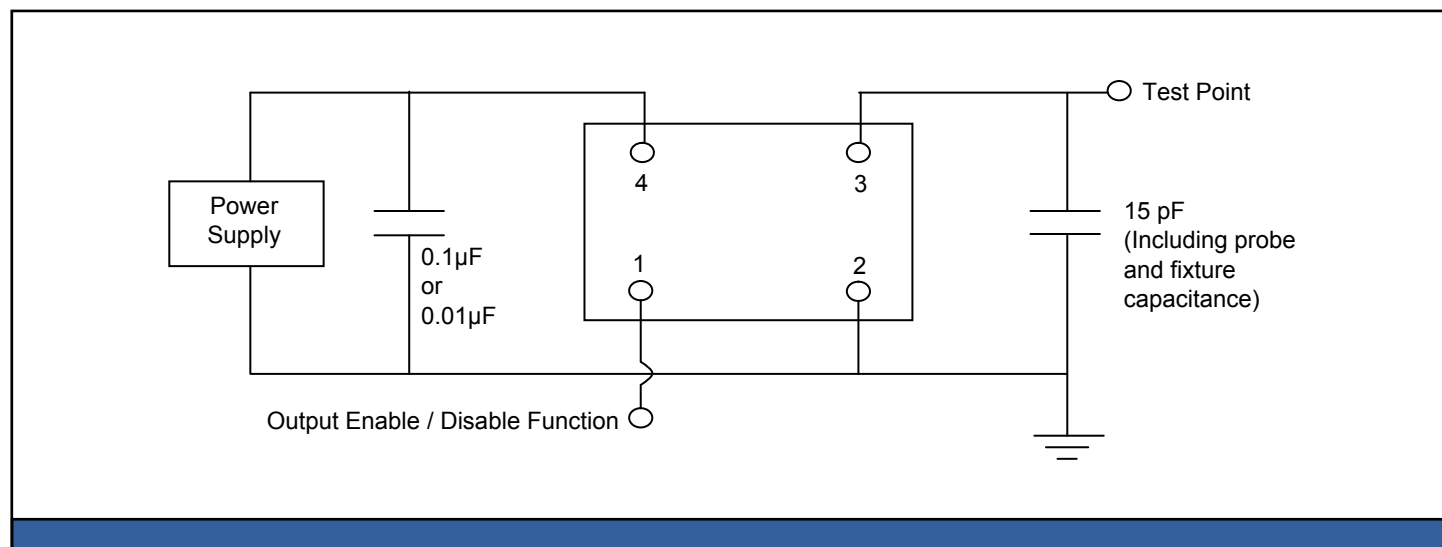
Typical Accumulated Jitter



Absolute Maximum Ratings

Parameter	Min.	Typ.	Max.	Units	Notes
Storage temperature	-55		+125	°C	

Test Circuit

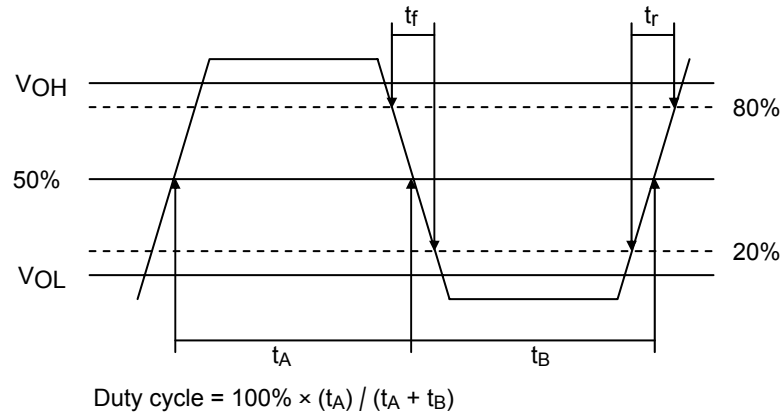


Reliability Test Ratings

This product is rated to meet the following test conditions:

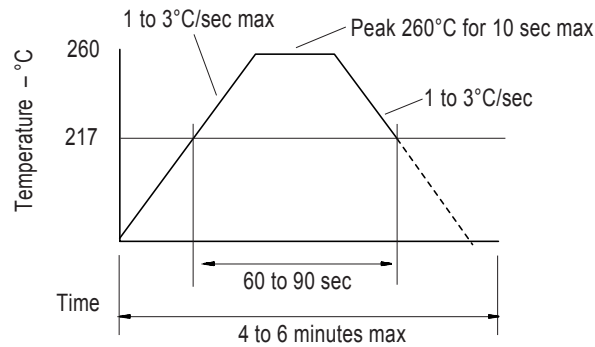
Type	Parameter	Test Condition
Mechanical	Shock	MIL-STD-883, Method 2002, Condition B
Mechanical	Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Mechanical	Terminal strength	MIL-STD-883, Method 2004, Condition D
Mechanical	Gross leak	MIL-STD-883, Method 1014, Condition C
Mechanical	Fine leak	MIL-STD-883, Method 1014, Condition A2 ($R_1 = 2 \times 10^{-8}$ atm cc/s)
Mechanical	Solvent resistance	MIL-STD-202, Method 215
Environmental	Thermal shock	MIL-STD-883, Method 1011, Condition A
Environmental	Moisture resistance	MIL-STD-883, Method 1004
Environmental	Vibration	MIL-STD-883, Method 2007, Condition A
Environmental	Resistance to soldering heat	J-STD-020C Table 5-2 Pb-free devices (2 cycles max)

Output Waveform

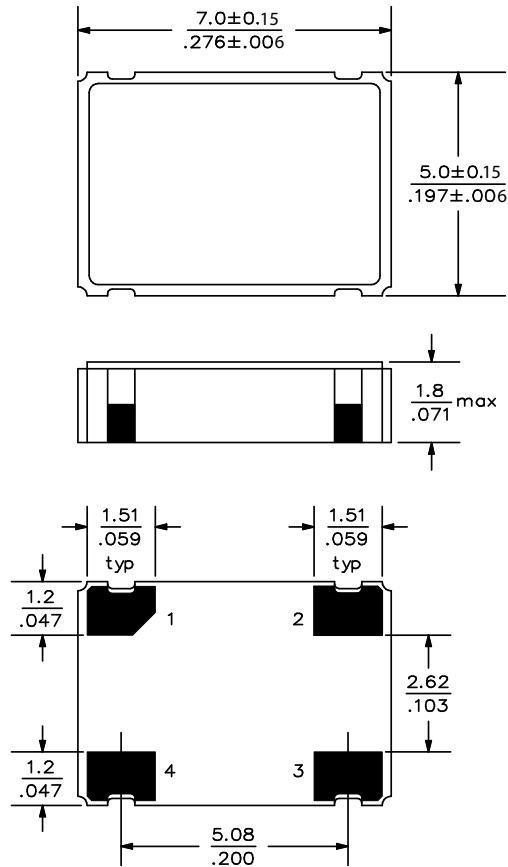


Reflow Soldering Profile

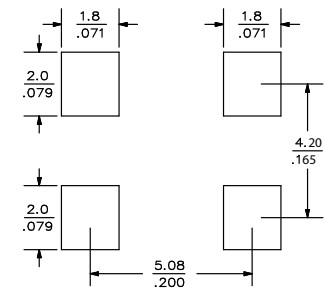
As per IPC/JEDEC J-STD-020C



Mechanical Drawings



Recommended Land Pattern*



*External high-frequency power decoupling is recommended. (see test circuit for minimum recommendation). To ensure optimal performance, do not route traces beneath the package.

Scale: None. Dimensions are in mm/inches.

Marking LINE 1: S P X (SaRonix, Model, Stability code)
Marking LINE 2: Frequency (Frequency code)
Marking LINE 3: ● YY WW X (Pin 1, Year, Week, Origin)

**Exact location of markings may vary.